

# HSP

**NOTES:**

Current Rating: 2.0AMP  
 Withstand Voltage: 500V AC/DC  
 Contact Resistance: 20mΩ Max  
 Insulation Resistance: 1000MΩMin  
 Operation Temperature: -40°C to +105°C

Contact Material: Phosphor Bronze  
 Contact plating: Au or Sn over Ni  
 Insulator Material: PA6T+30%G.F UL94V-0

## Ordering Information

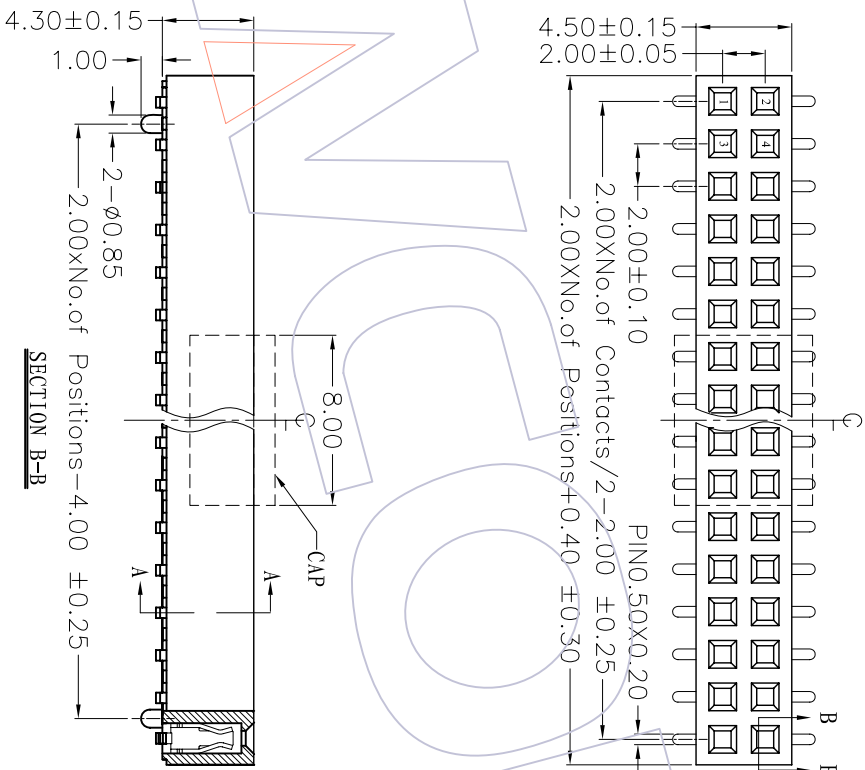
2243 - 2 XX M XX CUNT X

No. of Pins per Row: 30-40Pin

Contact Plating: G0=Gold Flash  
 G1=3μ"Gold  
 G2=5μ"Gold  
 G3=10μ"Gold  
 G4=15μ"Gold  
 G5=30μ"Gold  
 S0=Gold Flash/Tin  
 S1=3μ"Gold/Tin  
 S2=5μ"Gold/Tin  
 S3=10μ"Gold/Tin  
 S4=15μ"Gold/Tin  
 S5=30μ"Gold/Tin  
 SN=1Tin

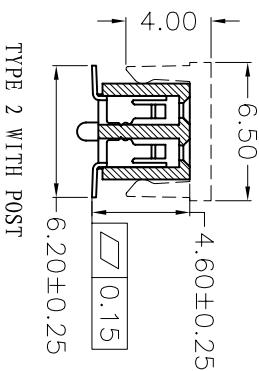
Packaging: T=Tube  
 R=Tray&Reel+CAP  
 P=Tray+CAP

Series No. 1=TYPE 1  
 2=TYPE 2

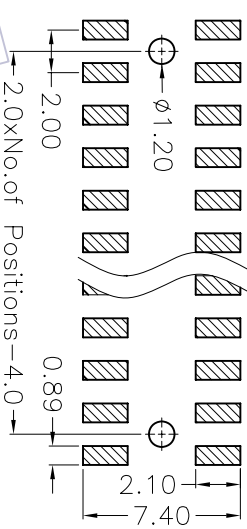


SECTION B-B

SECTION A-A



Recommended P.C.B Layout(TOP Side)  
 (PCB BOARD TOLERANCE±0.05)



REV	DATE	MODIFICATION DESCRIPTION	CHANGE	APPROVE	OPERATION	DRAW	SCALE	PART NO.
A0	08/02/28	NEW			X.X X.XX X.XXX	MeiLing 08.02.28	3:1 mm A4	SEE TABLE
1					Angle DIM	CHECK APPROVE	1/1 PROJ.	2.00mm DUAL FEMALE HEADER SWT H=4.3

**WCON** 维峰五金电子有限公司  
 WAFER HARDWARE ELECTRONICS CO. LTD

TYPE	PART NO.
TYPE 1	2243-2XXMXXCUNT1
TYPE 2	2243-2XXMXXCUNT2